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PATENT TRADEMARK OFFICE

## PATENT

Customer Number 22,852

Application No. 09/685,577

Attorney Docket No. 5725.0656-01

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Véronique FERRARI et al.

Application No. 09/685,577

Filed: October 11, 2000

For: COMPOSITIONS IN RIGID FORM  
STRUCTURED WITH A  
POLYMER

Group Art Unit: 1615

Examiner: Sheikh, H.

18 1/2 Suppl  
15 Privat  
H. w/alt

## MAIL STOP RCE

## Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Bel  
9-17-03

Sir:

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**  
**UNDER 37 C.F.R. § 1.97(b)**

Pursuant to 37 C.F.R. §§ 1.56 and 1.97(b), Applicants bring to the attention of the Examiner the documents listed on the attached PTO 1449. This Information Disclosure Statement is being filed before the mailing date of a first Office Action on the merits for the above-referenced application.

A copy of each of the listed documents is attached. Applicants respectfully request that the Office consider the listed documents and indicate that they were considered by making appropriate notations on the attached form.

With respect to the non-English language documents, Applicants submit the following remarks:

1. **DE 38 39 136 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

2. **DE 197 07 309 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.
3. **DE 197 50 246 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.
4. **EP 0 557 196 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.
5. **EP 0 609 132 B1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.
6. **EP 0 749 746 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent No. 5,945,095, which is believed to be an English language counterpart.
7. **EP 0 749 747 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent No. 5,851,517, which is believed to be an English language counterpart.
8. **EP 0 775 483 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent No. 5,972,354, which is believed to be an English language counterpart.
9. **EP 0 847 752 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.
10. **EP 0 879 592 A2** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

11. **EP 0 887 073 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent No. 6,203,780, which is believed to be an English language counterpart.

12. **EP 0 930 058 B1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

13. **EP 0 930 060 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent No. 6,254,877, which is believed to be an English language counterpart.

14. **EP 0 958 811 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

15. **EP 0 959 066 A2** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent No. 6,165,971, which is believed to be an English language counterpart.

16. **EP 0 959 091 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent Application Publication No. US 2002/0119171, which is believed to be an English language counterpart.

17. **EP 0 976 390 A1** -An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent Application Publication No. US 2001/0014313, which is believed to be an English language counterpart.

18. **EP 0 984 025 A2** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent No. 6,280,846, which is believed to be an English language counterpart.

19. **EP 1 002 514 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent No. 6,203,807, which is believed to be an English language counterpart.

20. **EP 1 031 342 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

21. **EP 1 048 282 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

22. **EP 1 053 742 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

23. **EP 1 064 919 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

24. **EP 1 064 920 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent No. 6,482,400, which is believed to be an English language counterpart.

25. **EP 1 066 814 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent No. 6,491,931, which is believed to be an English language counterpart.

26. **EP 1 068 854 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent No. 6,372,235, which is believed to be an English language counterpart.

27. **EP 1 068 855 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent No. 6,402,408, which is believed to be an English language counterpart.

28. **EP 1 086 945 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

29. **EP 1 090 627 B1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

30. **EP 1 114 636 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent Application Publication No. US 2001/0031280, which is believed to be an English language counterpart.

31. **FR 2 232 303** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith. Also submitted is U.S. Patent No. 3,937,811, which is believed to be an English language counterpart.

32. **FR 2 674 126** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

33. **FR 2 785 179** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

34. **FR 2 802 806** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

35. **FR 2 819 402** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

36. **JP 53043577 A** - An abstract of the disclosure of this document can be found in the English language Abstract from Patent Abstracts of Japan submitted herewith.

37. **JP 56123909 A** - An abstract of the disclosure of this document can be found in the English language Abstract from Patent Abstracts of Japan submitted herewith.

38. **JP 56166276 A** - An abstract of the disclosure of this document can be found in the English language Abstract from Patent Abstracts of Japan submitted herewith.

39. **JP 61065809 A** - An abstract of the disclosure of this document can be found in the English language Abstract from Patent Abstracts of Japan submitted herewith.

40. **JP 2127568 A** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

41. **JP 2216279** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

42. **JP 3014683 A** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

43. **JP 04346909 A** - An abstract of the disclosure of this document can be found in the English language Abstract from Patent Abstracts of Japan submitted herewith.

44. **JP 7179795 A** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

45. **JP 7267827 A** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.
46. **JP 8225316 A** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.
47. **JP 9295922 A** - An abstract of the disclosure of this document can be found in the English language Abstract from Patent Abstracts of Japan submitted herewith.
48. **JP 10259344 A** - An English language Abstract of this document can be found in the English language Abstract from Patent Abstracts of Japan submitted herewith.
49. **JP 11106216 A** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.
50. **WO 91/12793** - An English language Abstract of this document can be found on the front of this document.
51. **WO 94/21233** - An English language Abstract of this document can be found on the front of this document. Also submitted is U.S. Patent No. 5,612,043, which is believed to be an English language counterpart.
52. **WO 95/15741** - An English language Abstract of this document can be found on the front of this document.
53. **WO 95/33000** - An English language Abstract of this document can be found on the front of this document. Also submitted is U.S. Patent No. 5,747,625, which is believed to be an English language counterpart.

54. **WO 02/47605 A2** - An English language Abstract of this document can be found on the front of this document. Also submitted is U.S. Patent Application Publication No. US 2003/0044367, which is believed to be an English language counterpart.

55. **WO 02/47627 A1** - An English language Abstract of this document can be found on the front of this document. Also submitted is U.S. Patent Application Publication No. US 2003/0026772, which is believed to be an English language counterpart.

56. **WO 02/055031 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

57. **WO 02/056845 A1** - An abstract of the disclosure of this document can be found in the English language Derwent Abstract submitted herewith.

58. **FR 1 529 329** - A certified English translation of this document is enclosed.

This submission does not represent that a search has been made or that no better art exists and does not constitute an admission that each or all of the listed documents are material or constitute "prior art." If the Office applies any of the documents as prior art against any claim in the application and Applicants determine that the cited documents do not constitute "prior art" under United States law, Applicants reserve the right to present to the Office the relevant facts and law regarding the appropriate status of such documents.

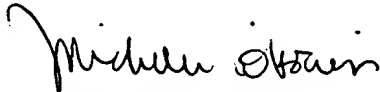
Applicants further reserve the right to take appropriate action to establish the patentability of the disclosed invention over the listed documents, should one or more of the documents be applied against the claims of the present application.



If there is any fee due in connection with the filing of this Statement, please  
charge the fee to our Deposit Account No. 06-0916.

Respectfully submitted,

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By:   
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